Temperature dependence of the resistance of metallic nanowires (diameter \( \geq 15 \text{ nm} \)): Applicability of Bloch-Gr"uneisen theorem.

Aveek Bid\textsuperscript{1\!*}, Achyut Bora\textsuperscript{1} and A. K. Raychaudhuri\textsuperscript{1,2}

\textsuperscript{1}Department of Physics, Indian Institute of Science, Bangalore 560 012, India
\textsuperscript{2}Unit for Nanoscience and Technology, S.N.Bose National Centre for Basic Sciences, Salt Lake, Kolkata 700098, India

We have measured the resistances (and resistivities) of Ag and Cu nanowires of diameters ranging from 15 nm to 200 nm in the temperature range 4.2 K-300 K with the specific aim to assess the applicability of the Bloch-Gr"uneisen formula for electron phonon resistivity in these nanowires. The wires were grown within polymeric templates by electrodeposition. We find that in all the samples the temperature dependence of resistance can be fitted to the Bloch-Gr"uneisen formula in the entire temperature range with a well defined transport Debye temperature (\( \Theta_R \)). The value of Debye temperature obtained from the fits lie within 8\% of the bulk value for Ag wires of diameter 15 nm while for Cu nanowires of the same diameter the Debye temperature is significantly lesser than the bulk value. The electron-phonon coupling constants (measured by \( \alpha_{el-ph} \) or \( \alpha_R \)) in the nanowires were found to have the same value as that of the bulk. The resistivities of the wires were seen to increase as the wire diameter was decreased. This increase in the resistivity of the wires may be attributed to surface scattering of conduction electrons. The specularity \( p \) was estimated to be about 0.5. The observed results allow us to obtain the resistivities exactly from the resistance and gives us a method of obtaining the exact numbers of wires within the measured array (grown within the template).

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I. INTRODUCTION

Resistivity \( (\rho) \) of a metallic nanowire is a topic of considerable current interest. For nanowires with diameters approaching molecular dimensions the transport is likely to be quantum in nature \cite{1}. However, there is a considerable size range (diameter > few nm) where the issues of quantum transport (like quantized conductance) are not important. Yet the study of the resistivity of such nanowire is of interest because this is likely to be the dimension of metallic interconnects in electronic devices in the near future. In this size regime the concepts of Boltzmann transport are at its limits of applicability. A proper understanding of the resistivity in this regime is needed because it allows one to get a quantitative estimate of the resistance of the wire from its dimension without actually measuring it. In the regime where the width of the wire is a few tens of nm or less, it has been established adequately that \( \rho \) is not determined by the material alone but by its size as well \cite{2,3,4,5,6}. For wires of these dimensions, the mean free path is comparable to or even larger than the wire width (particularly for clean wires) and one would expect the size effect to be operative. In this range, \( \rho \) typically increases as the width of the wire is decreased. This is a serious issue in interconnects as an increase in the resistance of the wire increases the propagation delay time constant of the system and hence slows down the speed of the device. Recent investigations have focused on understanding the size effect in wires of width < 100 nm so that a predictive relation can be obtained \cite{2,3,4,5,6}. The problem gets complicated due to the added contribution of grain boundary scattering. The size effect (arising mainly from the surface scattering) and the internal grain boundary scattering (along with scattering form impurities or point defects) constitute the temperature independent part of the resistivity and this shows up as the residual resistivity at \( T \leq 20K \) in most metallic solids. (If the wire is disordered the resistivity instead of showing a constant residual value at the low temperature can show an upturn often associated with effects such as localization \cite{7}.) Understanding these effects for a nanowire will thus give us a control on the residual resistivity of the nanowire. However, understanding the residual resistivity alone is not enough to get a complete understanding of the \( \rho \) in nanowires because at room temperatures, for a good metallic nanowire, a substantial part of the resistivity should arise from the temperature dependent part which in a non-magnetic metal arises from the electron-phonon interaction \cite{8}. A good estimate and a quantitative way of predicting the resistivity contribution from the electron-phonon interaction is thus needed. In this paper the principal focus is on the specific issue of the contribution of electron-phonon scattering to the resistivity of metallic nanowires and we establish by experiments to what extent such established theory as the Bloch-Gr"uneisen theory \cite{8} is applicable as the wire diameter goes down to as small as 15 nm.

Temperature dependence of the resistivity of nanowires have been studied both theoretically as well as experimentally \cite{4,10,11,12,13,14}. Previous experimental studies on nanowires of elemental metals and alloys have established that in wires with diameter (or width) \( \geq 15 \text{ nm} \), the temperature dependence of resistance is
metallic reaching a residual resistivity at low temperature (if the wires are not disordered with ) for . For wires with smaller diameter and width (typically ) the resistivity can have a negative temperature coefficient. This has been seen in wires of Au [8], AuPd alloy [9], Zn [10], Cu [12] and Sn [13] (before it becomes superconducting at ). However, there has not been any experimental study that specifically addresses this issue in well characterized nanowires over an extensive range of temperatures and wire diameters and analyzes the data quantitatively. With these objectives we have studied the resistance of metallic nanowires (silver and copper) as a function of the wire diameter (15 nm-200 nm) in the temperature range 4.2 K-300 K. The systematic investigation allows us to separate out the temperature independent part from the temperature dependent part (we write ). We analyzed the data in the framework of the Bloch-Grüneisen theory. This allowed us to estimate the effective Debye temperature from the temperature dependence of the resistance. In addition, a clear evaluation of the residual resistivity allowed us to establish the dependence of the resistivity on the diameter of the wire. To our knowledge this is the first experimental study of the resistance of metallic nanowires over such an extensive range of temperature and size where the applicability of the Bloch-Grüneisen formula has been tested quantitatively.

II. ELECTRON-PHONON INTERACTION AND THE BLOCH-GRÜNEISEN FORMULA

The electron-phonon interaction and the Bloch-Grüneisen formula have been adequately discussed in standard text books [5]. However, for the purpose of quick reference as well as for completeness we give the important relations briefly in this section. In a non-magnetic metallic crystalline solid the temperature dependence of the electrical resistivity arises mainly from the electron-phonon interaction [5] and can be explained in the framework of the Boltzmann transport theory using the Bloch-Grüneisen formula:

\[ \rho(T) = \rho(0) + \rho_{el-ph}(T) \]

\[ \rho_{el-ph}(T) = \alpha_{el-ph} \left( \frac{T}{\Theta_R} \right)^n \int_0^{\frac{\Theta_R}{T}} \frac{x^n}{(e^x - 1)(1 - e^{-x})} dx \] (1)

where is the residual resistivity due to defect scattering and is essentially temperature independent. The temperature dependent part of the resistivity arises from electron-phonon interaction. The constant generally takes the values 2.3 and 5 depending on the nature of interaction and for a non magnetic elemental metal like Cu, Ag or Au with reasonable mean free path of m. is a constant that is . Here is the electron-phonon coupling constant, is the Debye frequency and is the plasma frequency. is the Debye temperature as obtained from resistivity measurements and matches very closely with the values of Debye temperature obtained from specific heat measurements. In the case of bulk silver and copper with , and AuPd alloy [10], Zn [11], Cu [12] and Sn [13] respectively [15].

In Bloch-Grüneisen formula, the phonons that contribute to the electron-phonon interaction are the acoustic phonons and one can get a simple one parameter scaling of the temperature dependence of the resistivity ( ) where the only relevant parameter is the Debye temperature . For the specific case of :\n
\[ \frac{\rho_{el-ph}(T)}{\rho_{\Theta_R}} = \frac{R(T)}{R_{\Theta_R}} = \frac{\rho_{el-ph}(T)}{\rho_{\Theta_R}} \] (2)

where is the resistivity at the temperature and is the Debye temperature. For acoustic phonons the value of is 4.225 [19]. Even when there is an uncertainty in the physical dimensions (that introduces uncertainty in the determination of ) the above relation can be utilized because one can write

\[ \frac{R(T) - R_{4.2K}}{R_{\Theta_R}} = \frac{\delta R(T)}{R_{\Theta_R}} = \frac{\rho_{el-ph}(T)}{\rho_{\Theta_R}} \] (3)

The measurements carried out in this paper also allow us to investigate how the electron-phonon interaction gets modified in nanowires due to size-reduction and manifests itself in the temperature dependence of the resistance. The lower limit of the integral in equation being zero is the result of a tacit assumption that we are dealing with bulk material and hence the system size does not impose a boundary condition on the maximum allowed phonon wavelength. This assumption may no longer be valid for wires of very small diameters. Thus the lower limit in the integral will now have a finite non-zero value. We wanted to investigate at what diameters of the wire does the size really begin to affect the phonon spectrum (and hence the electrical resistivity) of the wire.

III. EXPERIMENTAL

The nanowires of Ag and Cu with average diameters in the range of 15 nm-200 nm and length 6µm were electrochemically deposited using polycarbonate membranes as template from AgNO₃ and CuSO₄ respectively [20, 21]. Schematic arrangement of the growth set-up is given in figure 1(a). During the growth, one of the electrodes was attached to one side of the membrane while the other electrode was a micro-tip of radius of curvature of 100µm fitted to a micropositioner. This electrode can be placed at a specific area on the membrane and the growth can thus be localized. The wires grow by filling the pores
from end to end and as soon as one or more wires complete the path from one electrode to the other the growth stops. The wires after growth can be removed from the membrane by dissolving the polymer in dichloromethane. This is needed for the microscopic characterization of the wires as described below. The wires after growth were annealed at 375K for 24 hours in vacuum under a dc current of 1 mA. The post-deposition annealing is needed to stabilize the resistance of the wires. For all successive measurements the current through the sample was kept lower than 100 μA.

The structural and crystallographic nature of the wires form an important part in the analysis of the data. The wires used in this investigation are single crystalline in nature. This has been established by such techniques as X-ray diffraction (XRD), Field Emission Gun-Scanning Electron Microscope (FEG-SEM) and High resolution transmission electron microscope (HRTEM). The TEM was done in a Tecnai G² 30 machine operated at 300KV with a nominal magnification of $10^6$.

IV. BASIC RESULTS

The XRD data are shown in figure 1(b). The XRD data were indexed as FCC lattice. The data as shown in figure 1(b) does not show any impurity peak. Similar data were also obtained for Cu and are not shown to avoid duplicity.

![FIG. 2: SEM image of (a) 100 nm Ag wires taken after dissolving off the template in dichloromethane, (b) SEM image of a single 200 nm Ag wire.](image)

Figure 2(a) shows the SEM image of a collection of Ag nanowires of diameter 100 nm taken after partially removing the membrane while figure 2(b) shows the SEM image of a single Ag wire of diameter 200 nm. The average diameter of the wires match with the nominal diameter of the pores of the templates in which they were grown.

In figure 3 we show a typical TEM data taken on a 15 nm Ag wire. The diffraction data are also shown and can be indexed into (220) planes. The TEM data show that the wires are single crystalline with the presence of twins in them. They also show that there are no other substantial structural defects like grain boundaries or dislocations present in the sample. The growth direction as seen from the TEM data is [100].

![FIG. 1: A schematic of the set up used for making the nanowires. (b) XRD of 100 nm Ag wires. The peaks have been indexed to FCC Ag.](image)
The resistance of the wires was measured in a bath type helium cryostat in the temperature range 4.2K-300K using an ac phase-sensitive detection using a lock-in amplifier. The measurements were carried out by retaining the wires within the polymeric membrane. On each of the two sides of the membrane two electrical leads were attached using silver epoxy. Though the measurements were made with the wires retained within the membrane, the system is an array of parallel nanowires where the individual wires are well separated by the insulating membrane. A typical sample may contain 2 to 50 wires. A very important issue in this measurement is the contribution of the contacts to the measurement. We have paid attention to this aspect and measured the resistance by making the contact in different ways. In addition to silver epoxy contacts, we used evaporated silver films to make contact which we find gave similar results. We also made contacts using wires tinned with Pb-Sn solder where we find that the change in the resistance of the sample as we go below the superconducting transition temperature (∼7K) of the solder is negligibly small (≤2−3%). All these tests rule out any predominant contribution from the contacts. In the context of this paper we note that the small contact resistance even if it is present will make a small additive contribution to the temperature independent part of the resistance only. The particular issue of contact resistance as well as contact noise have been discussed in somewhat details in previous publications by the group [21] [22].

Figure 4 show the collection of resistance data on arrays of Ag wires with diameters ranging from 15 nm-200 nm. The insets show the same resistance plotted with a logarithmic scale for the temperature axis to show more clearly the low temperature behavior of the resistance. The data for the Cu nanowires are shown in figure 5. The resistance data are typical of a good metal. Both the Ag and Cu nanowire arrays have a fairly linear temperature dependence of resistance down to about 100 K and reach a residual resistance below 40−50K with a residual resistivity ratio (RRR) \(\frac{\rho_{300K}}{\rho_{4K}}\) ∼ 3. The resistance does not show any upturn at low temperature thus ruling out any significant disorder in the system that can give rise to effects such as localization [23]. The values of temperature coefficient of resistivity \(\beta = 1/R(dR/dT)\) for the wires lie within ∼4×10⁻³/K and ∼2.5×10⁻³/K respectively at 300 K. This matches well with the values...
for high purity Ag and Cu (approximately $3.8 \times 10^{-3}/K$ and $3.9 \times 10^{-3}/K$ respectively [26]). This also emphasizes the essential defect free nature of the wires (as also established by the TEM images) as the presence of defects can reduce the value $\beta$ significantly. When the mean free path $l_{mf}$ is so small that one reaches the Ioffe-Regel criterion $kFm_{f}l \approx 1$ [27], $\beta$ becomes very small ($\ll 10^{-4}$) [26].

V. DISCUSSION

A. Applicability of Bloch-Grüneisen theorem

We fitted the observed resistance data to the Bloch-Grüneisen function (equation 1) and made the important observation that the resistance data for wires of all diameters (in the range 15 nm- 200 nm) could be fitted to the above mentioned function over the entire temperature range (4.2 K-300 K) of investigation for integral values of $n$ using the Debye temperature ($\Theta$) and $e_{el-ph}$ as the only two adjustable fit parameters. The fit parameters were optimized to give a relative fit error (defined as $(R_{measured} - R_{fit})/R_{measured} \times 100\%$) of less than $\pm 0.5\%$ or better over the whole temperature range. A typical fit is shown in figure 6 for Ag wires of diameter 15 nm. In the inset we show the fit error which is less than $\pm 0.2\%$. It was seen that $n = 5$ gave the best fit for the wires. The values of $\Theta$, as obtained from the fits (with $n = 5$), are tabulated in table 1. Note that for the fit to the Bloch-Grüneisen function we have used the resistance data directly because, as explained later, there is a substantial uncertainty in the determination of the number of wires in an array. The use of the resistance data for the fit does not change $\Theta$. (Note: We use $a_{el-ph}$ as a fit parameter in this case. This is related to $a_{el-ph}$ by

$\tau_{el-ph} = \frac{1}{\omega_{el-ph}}$. $l$ and $A$ are the length and area of cross-section respectively and are known from experiment. Using the method discussed later in this paper (and appendix-A) we could calculate the value of $N$ more accurately and hence the value of $a_{el-ph}$ from the fit parameter $a_{el-ph}$. The value of $a_{el-ph}$ thus estimated is $\approx 4.6 \times 10^{-8} \Omega m$ for the Ag and $\approx 4 \times 10^{-8} \Omega m$ for Cu wires. This implies that the coupling constant is essentially unchanged on size reduction.

The values of $\Theta$ for all the samples measured were found to be close to but significantly smaller than the bulk value as measured in a reference sample. (For a reference sample we used a thermally evaporated high quality Ag thin film of thickness 150 nm. The film was evaporated in UHV chamber with a base pressure 10$^{-8}$ mbar from an effusion cell. It has a room temperature resistivity of $1.63 \times 10^{-8} \Omega m$ and a residual resistivity ratio of about 10. $\Theta$ for this sample matches with that of the bulk.) Analysis of the data as summarized in table 1, indicate that $\Theta$ has a reduction of $\approx 8\% - 15\%$ for Ag and $\approx 25\% - 40\%$ for Cu. The analysis thus gives us a direct way to estimate the Debye temperature in the nanowires. The observation of a softening of $\Theta$ is significant as also the fact that it is material dependent, being strong in Cu and not so significant in Ag.

The applicability of the Bloch-Grüneisen theorem can be better appreciated when we analyze the data using the scaling equation 2. We checked the scaling equation by plotting (see figure 7) $\frac{R_{measured}}{R_{fit}}$ as a function of $\frac{T}{\Theta}$. Here $R_{D}$ is the value of the measured resistance at $T=\Theta$. It can be seen that all the resistance data collapse into one curve signifying that the one parameter scaling law holds. From table I it can be seen that the value of the constant $\alpha_{R}$ is roughly the same for all the nanowires and is the value ($=4.225$) predicted by the simple acoustic phonon-electron coupling theory [12]. The observation that the Bloch-Grüneisen theorem is quantitatively applicable in the nanowires of at least two materials studied down to 15 nm diameter is extremely important. It establishes that the temperature dependent part of the resistivity (as arising from the electron-acoustic phonon interaction) is unchanged on size reduction down to 15 nm. The implication of the observation is that one now has a tool for determining $\Theta$.

TABLE I: The values of $\Theta$ and $\alpha_{R}$ (see equation 9) obtained from resistance data for Ag and Cu wires of different diameters. $\Theta$ for bulk Ag and Cu are 200K and 320K respectively.

<table>
<thead>
<tr>
<th>Sample</th>
<th>diameter (nm)</th>
<th>$\Theta$ (K)</th>
<th>% reduction</th>
<th>$\alpha_{R}$</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ag</td>
<td>15</td>
<td>184</td>
<td>8</td>
<td>4.226</td>
</tr>
<tr>
<td>Ag</td>
<td>30</td>
<td>170</td>
<td>15</td>
<td>4.227</td>
</tr>
<tr>
<td>Ag</td>
<td>100</td>
<td>174</td>
<td>13</td>
<td>4.225</td>
</tr>
<tr>
<td>Ag</td>
<td>200</td>
<td>187</td>
<td>6.5</td>
<td>4.226</td>
</tr>
<tr>
<td>Cu</td>
<td>15</td>
<td>180</td>
<td>43</td>
<td>4.271</td>
</tr>
<tr>
<td>Cu</td>
<td>30</td>
<td>235</td>
<td>26</td>
<td>4.224</td>
</tr>
<tr>
<td>Cu</td>
<td>50</td>
<td>231</td>
<td>28</td>
<td>4.225</td>
</tr>
<tr>
<td>Cu</td>
<td>200</td>
<td>200</td>
<td>37</td>
<td>4.235</td>
</tr>
</tbody>
</table>

FIG. 6: Fit to Bloch-Grüneisen formula (equation 11) to the measured resistivity data for 15 nm Ag wire. The inset shows the fit error (for definition see text) for $n = 5$.
FIG. 7: Plot of \( \frac{R - R_{\text{Debye}}}{R_D} \) as a function of \( \frac{T}{\Theta_R} \). Here \( R_D \) is the value of the measured resistance at \( T = \Theta_R \).

with which one can obtain the electron-phonon contribution to the resistivity with good quantitative accuracy. We will show below that this basic observation can be utilized to calculate/estimate the resistivity of metallic nanowires even if the exact number of wires in an array is not known.

The number of wires in such a sample of array vary from about 2 to 50 as was estimated using the bulk value of the resistivity. This is a very rough estimate as the resistivity in this range depends on the diameter/width of the wire. Hence we do not use this in our calculations. It is to be noted that the exact value of the resistivity is not needed to check the applicability of the Bloch-Grüneisen theorem as the analysis for the determination of \( \Theta_R \) were carried out using the resistance instead of the resistivity. Neither is the exact value of \( \rho \) needed to check equation (2). As a result the exact number of wires in the array was not needed for any of the evaluation so far.

Below we describe a method of estimating the resistivity of the samples which also gave us a better estimate of the number of wires in each sample.

B. Dependence of phonon contribution to resistance on the size of the wire

The applicability of the Bloch-Grüneisen theorem would imply that the basic electron-acoustic phonon interaction as well as the simple Debye phonon spectrum (phonon density of states \( \propto \omega^2 \) where \( \omega \) is the phonon frequency ) remains unchanged on size reduction. This would raise the question - to what size one can reduce the wire diameter before the deviation from simple Bloch-Grüneisen theorem begins to show up. To estimate the effect of size reduction, if any, on the phonon contribution to the resistance of a wire, we study the variation of the integrand of equation (4) as a function of \( x \) (where \( x = \Theta / T = hc / \lambda k_B T \). Here \( c \) is the sound velocity averaged over all the acoustic modes and \( \lambda \) is the phonon wavelength.) At a given temperature \( T \) the dominant contribution to the integral in equation (4) comes from the value of \( x \) for which the integrand has a maximum. We define this value of \( x \) as \( x_d \), the dominant value of \( x \) at a given temperature. \( x_d \) depends on the value of \( n \) ( for \( n = 5 \), \( x_d = 5 \)). Thus at a temperature \( T \) the phonons having a wavelength \( \approx \lambda_d = hc / x_d k_B T = hc / 5k_B T \) are the dominant phonons that contribute most to the temperature dependent part of the resistance of a metal. The values of \( \lambda_d \) (for \( n = 5 \)) as a function of temperature \( T \) are plotted in figure 8. We can see from the plot that even at 4.2 K, the value of \( \lambda_d \) is much smaller than 10 nm. Thus for a wire of diameter 15 nm, the phonons that make the maximum contribution to the temperature dependent part of the resistance (down to the lowest temperature measured) are not affected by the wire dimensions. At higher temperatures \( \lambda_d \) becomes smaller ( being \( \propto 1/T \)). So in all the samples studied by us down to the lowest diameter phonon confinement is not an issue and hence contribution to the temperature dependent part of the resistivity is expected to follow the same Bloch-Grüneisen function valid for a 3D bulk metal albeit with a reduced \( \Theta_R \). To test the effect of phonon confinement and to evaluate the effect of finite size of the wire on the electron-phonon part of the resistivity, we have fitted the resistance data to the Bloch-Grüneisen function with the lower limit of the integral changed to \( x_{\text{min}} = \theta_{\text{min}} / T \) where \( \theta_{\text{min}} = hc / dk_B \) (\( d \) being the diameter of the wire). We do not find any significant change in the quality of the fit or in the value of the fit parameters. This is because even for wires of diameter 15 nm, \( x_{\text{min}} \sim 0.5 \) at 30K and the values of \( x \)
in this range hardly make any contribution to the Bloch-
Gr"uneisen integral in equation [4]. Presumably at even
lower temperatures $T < 0.5K$ one would expect that for
wires of this size the finite size effect should show-up in
the Bloch-Gr"uneisen estimate of the temperature depend-
ent part of the resistivity $\rho$. However, in this tempera-
ture range in a real wire the residual resistivity will mask
any effect of the temperature dependent part.

C. Estimation of resistivity from the resistance
data and its dependence on wire diameter

We noted before that the evaluation of the resistivity
from the directly observed resistance data is prone to
to error due to the uncertainty in the actual number of wires
that make up the array. The observation that the phonon
contribution to the electrical resistance of the nanowires
is unchanged from that of the bulk allows us to estimate
the value of the resistivity of the wires from the measured
resistance without having to know the number of wires
present in the sample. We elaborate this in Appendix-A.
Let the resistance of one wire be $R_1 = \rho l/A$, where $\rho$
the resistivity of the material, $l$ is the length and $A$ is the
cross-sectional area of the wire. Therefore resistance of
$N$ identical wires in parallel is

$$R_N = \rho l/AN.$$  (4)

The facts that the temperature dependence of the resis-
tivity arises from the electron-phonon interaction and
that the same relation (with the same $\alpha_{el-ph}$ and $\alpha_R$)
governs the electron-phonon interaction in the nanowire
as in the bulk crystalline material can be utilized to get
(see appendix-A):

$$\rho = \rho_0 \frac{\Theta_{R0}}{\Theta_R} \
 \left[\frac{1}{R_N} \left(\frac{dR_N}{dT}\right)\right]$$  (5)

where $\beta = [1/R_N(dR_N/dT)]$ is the measured tem-
perature coefficient of resistivity (TCR) of the wire array, $\beta_0$
the temperature coefficient of resistivity of the bulk ma-
terial, $\rho_0$ is the bulk resistivity at that temperature and
$\Theta_{R0}$ is the Debye temperature of the bulk material. (This
equation is valid strictly in the high temperature limit
where the temperature dependent part of the electrical
resistivity of a metal is only due to phonon scattering.
In the nanowires used by us the temperature dependent
part solely arises from the electron-phonon interaction,
as established by analysis of the data in the previous sec-
tion.)

We calculate the TCR from the measured resistance
near room temperature. Using the resistivity at 295K
thus estimated and from the measured resistance of the
wire arrays we can find the number of wires in a given
array ($N$) using equation [4]. From this we can evaluate
the resistivity as a function of temperature for all the
wires. This is shown in figure 9 for Ag wires as well as
the Cu wires. One can see a systematic variation of $\rho$ as a
function of temperature for wires of different diameters.
The value of the resistivity at 295K, the residual resistiv-
ity as well as the mean-free path ($l_{mfp}$) of the electrons
calculated from the resistivity at T=295K are shown in
table 2. For this calculation we assumed bulk electron
density. In figure 10(a) we also plot the residual resistiv-
ity $\rho_{4,2K}$ as well as the $\rho_{295K}$ as a function of $d$ for the
Ag wires. (The bulk value of the resistivity of high purity
Ag ($1.6 \times 10^{-8} \Omega m$) at 295K is shown as an arrow.)
We have plotted the ratio $l_{mfp}/d$ at 295 K as a function of
$d$ in figure 10(b). It clearly shows that in wires of small
diameters the $l_{mfp}$ can be substantially larger than $d$ and
that the ratio $l_{mfp}/d$ increases as $d$ is reduced. For wires
of diameter 15 nm $l_{mfp}/d$ approaches a value 1.5. We
also note that the value of $k_Fl$ is significantly larger than
1 thus justifying the applicability of the Bloch-Gr"uneisen
theorem in these samples.

From table [II] as well as from figures 9 and 10 we can
see that there is a significant increase in the residual resis-
tivity as the diameter of the wires is decreased. The
increase is systematic. All wires have the same chemical
purity and hence the enhancement of $\rho_{4,2K}$ on reduction
of $d$ is not due to impurity contribution. For wires in the
diameter range that we are studying, the resistivity is ex-
pected to increase with a decrease in the wire diameter
due to 2 probable reasons:

- As the mean free path of the electrons is now of the
  order (and in some cases larger than) of the diam-

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FIG. 9: Plot of the resistivity of Ag and Cu nanowires as a
function of temperature. The resistivity were obtained using
the method described in the text.

TABLE II: The values of $\rho$ at 295 K, the residual resistiv-
ity at 4.2 K and $l_{mfp}$ at 295 K for wires of different diameters.

<table>
<thead>
<tr>
<th>Sample</th>
<th>diameter (nm)</th>
<th>$\rho_{295K}$ ((\mu\Omega)cm)</th>
<th>$\rho_{4,2K}$ ((\mu\Omega)cm)</th>
<th>$l_{mfp}$ (nm)</th>
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<tr>
<td>Ag</td>
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</tbody>
</table>
The TEM images show that there are no significant presence of grain boundaries in the wires studied by us. The twin boundaries seen are generally weak scatterer and do not contribute significantly to the resistivity. We analyze the resistivity data in the light of surface scattering model of Dingle [27] and Chambers [28]. According to these authors, for cylindrical wires of isotropic metal, the dependence of the resistivity on the wire diameter goes as:

$$\rho_d = \rho_0 + \rho_0(1 - p)l_0/d$$  \hspace{0.5cm} (6)

where \(\rho_d\) is the resistivity of the wire of diameter \(d\), \(\rho_0\) is the “bulk” or the so called “intrinsic” resistivity for the material of the wire, \(p\) is the specularity that denotes the fraction of conduction electrons undergoing specular reflection at the wire surface and \(l_0\) is the bulk mean free path. The quantity \(\rho_0l_0\) is the property of the wire and is temperature independent. To check the validity of the model we have evaluated the value of \(\rho_0l_0\) at several different temperatures and got similar values to within \(\pm 3\%\). For Ag wires \((\rho_0l_0 \approx 5.5 \times 10^{-16} \text{Ωm})\). (Note: In this analysis we use only the data of Ag wires as they are of higher chemical purity and contain less density of defects.) In figure 10(a) we show calculated value of \(\rho_d\) for \(p \approx 0.5\). The calculated values closely match the observed data. The value of specularity factor \(p \approx 0.5\) obtained from our data is very close to the values (0.3-0.5) reported previously for metallic films of similar dimensions [2, 4].

To summarize, we have measured the resistances (and resistivities) of Ag and Cu nanowires of diameters ranging from 15 nm up to 200 nm in the temperature range 4.2-300K. We find that the temperature dependence of resistance can be fitted to a Bloch-Grüneisen formula in the entire temperature range. This ensures that the Debye temperature is a viable parameter and this allows us to obtain a value for the Debye temperatures. The values of Debye temperature obtained form the lay the fits within \(8\%\) of the bulk value for Ag wires of diameter 15 nm. However, there is significant softening of the Debye temperature for Cu nanowires with the same diameter. The electron-phonon coupling constants (measured by \(\alpha_{el-ph}\) or \(\alpha_R\)) in the nanowires were found to have the same value as the bulk. The resistivities of the wires were seen to increase as the wire diameter was decreased. This increase in the resistivity of the wires may be attributed to surface scattering of conduction electrons. The specularity \(p\) was estimated to be about 0.5.

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APPENDIX A

The resistivity $\rho$ can be written as $\rho(T) = \rho(0) + \rho_{el-ph}(T)$ where $\rho_{el-ph}(T)$ is the temperature dependent part of the resistivity due to the phonons and $\rho(0)$ is the residual resistivity due to defect and surface scattering. The fact that the grain boundary scattering and surface scattering contributions to the resistivity is independent of temperature (at least at high temperatures) has recently been shown experimentally [3]. So we can have

$$\frac{d\rho}{dT} = \frac{d\rho_{el-ph}}{dT}$$

At high temperatures, $d\rho/dT \propto 1/\Theta_R$ and since the coupling constant $\alpha_{el-ph}$ is nearly the same for all the nanowires with the same chemical elements (established by this experiment) we can write:

$$\frac{d\rho_{el-ph}}{dT} = \frac{d\rho_{el-ph}(0)}{dT} \Theta_{R0} = \frac{d\rho_0}{dT} \frac{\Theta_{R0}}{\Theta_R}$$

where $\rho_0$ refers to the bulk resistivity of the material and $\Theta_{R0}$ is the bulk Debye temperature. From equation (A1) we get:

$$\frac{dR_N}{dT} = \frac{l}{NA} \frac{d\rho}{dT} = \frac{l}{NA} \frac{d\rho_0}{dT} \frac{\Theta_{R0}}{\Theta_R}$$

$$= \frac{\rho_0}{NA} \frac{\Theta_{R0}}{\Theta_R} \beta_0 = \frac{R_N \rho_0 \Theta_{R0}}{\rho \Theta_R} \beta_0$$

(A3)

where $\beta_0$ is the temperature coefficient of resistivity of the bulk material. Equation (A3) immediately yields

$$\rho = \rho_0 \frac{\Theta_{R0}}{\beta \Theta_R}$$

(A4)

where $\beta = [1/R_N(dR_N/dT)]$ is the measured temperature coefficient of resistivity of the wire array.